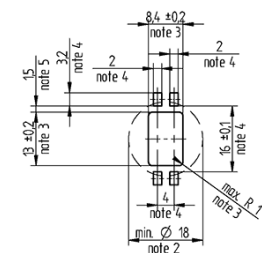
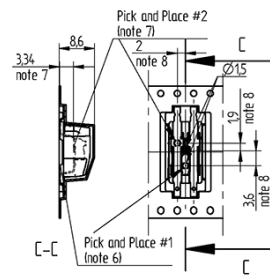
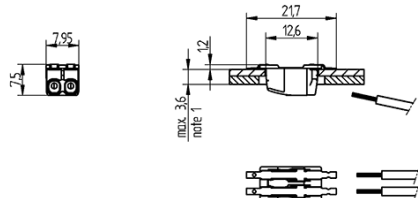
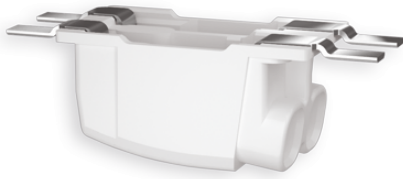




SMD Push through terminal block - 2 pole

46.112.1001.50

Technology for Light



8.0 + 1 mm



0.20-0.50 mm² AWG
24-20



0.20-0.75 mm²



SMD Push through terminal block - 2 pole

46.112.1001.50

Technology for Light

DESCRIPTION

No tools required! Wires can be released by twisting and pulling the wire simultaneously.

Terminal block and ballast on same working level

Note 1: Maximum thickness of PCB and heatsink should not exceed 3.6 mm

Note 2: Recommendation for opening in heatsink is shown with minimum diameter. For other shaped pockets in heatsink the minimum creepage and clearance distances and manufacturing tolerances have to be considered.

Note 3: Recommended dimension for opening in PCB

Note 4: Recommended dimension for solder mask

Note 5: For metal core PCBs the minimum creepage distance has to be guaranteed

Note 6: Recommended pick & place area #1

Note 7: Recommended pick & place area #2 inside of the connector. Max. diameter of nozzle is 2.5 mm.

Note 8: Distance from center of mass to pick and place area #1 and #2

General note: It is recommended to make an electrical connection between both poles of each polarity on the solder mask

Other packaging units on request

Product name: SMD Push through terminal block - 2 pole

Mounting method 1: Solder fixing

Material: Housing: PPA Contacts: Cu alloy

ENEC Rating: 9A / 320V (EN 60947-7-4) - 0.2-0.75mm² 9A / 500V (EN 60598-1) - 0.2-0.75 mm² , pitch min. 6.25mm

[URus Rating]: 9A / 300V

Wiring: from below the PCB

Approval: IEC 60947-7-4, additional cURus

cULus file no.: E-365006

cUR Rating: 9A / 320V

Quantity of poles: 2

Weight: 0,5

Pkg.: 5000
